IPC ASSOCIATION ELECTRONICS	© Copyright 2005.	Material Composition Declara © Copyright 2005. IPC, Bannockburn, I international and Pan-American copyrig		rn, Illinois, All rights reserved under both		This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute								Materials an	ials and Mfg Information				
upplier	Information													
Company name*				Company unique ID			Unique ID Authority				Response Date*			
onsemi											2024-05-01			
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	Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	1N5338BRLG ZEN SUR40 REG		5W 5.1V TR		2024-05-01		CNP		607.0	mg	Each			
	cturing Process Informa		F 1 D	A.11	CTD 020 MC	I. Dadin a	De els Desere	De des Transcon	Man Time	- A Doods Town	N	on of Definer Co	-1	
	8				-STD-020 MS	L Rating	Peak Process Body Temperature Max Time 0 C 30		Γ.					
	Matte Tin (Sn) - annealed		CU Alloy	IN IN	(A		U	IC	30	Se	econds 3			
omments														
	nformation regarding materia													

RoHS Material Composition Declaration			Declaration Type *	Detailed						
RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, supplier correct components, supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.5	mg	Supplier	Silicon (Si)	7440-21-3		4.5	mg
Die Attach Solder	21.29	mg	Supplier	Silver (Ag)	7440-22-4		0.5323	mg
			A	Lead (Pb)	7439-92-1	7a	19.6933	mg
			Supplier	Tin (Sn)	7440-31-5		1.0645	mg
Lead Frame	333.62	mg	В	Nickel (Ni)	7440-02-0		3.6698	mg
			Supplier	Copper (Cu)	7440-50-8		329.9502	mg
Mold Compound-Black	239.19	mg		Metal Hydroxide	proprietary data		11.9595	mg
			Supplier	Carbon Black (C)	1333-86-4		2.3919	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		179.3925	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		23.919	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		21.5271	mg
Plating	8.4	mg	Supplier	Tin (Sn)	7440-31-5		8.4	mg